

## PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Liang LI</td> <td>09/05/2013</td> </tr> <tr> <td>Wei LU</td> <td>09/05/2013</td> </tr> </tbody> </table>		Name	Execution Date	Liang LI	09/05/2013	Wei LU	09/05/2013				
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>GLOBALFOUNDRIES Singapore Pte. Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>60 Woodlands Industrial Park D Street 2</td> </tr> <tr> <td>City:</td> <td>Singapore</td> </tr> <tr> <td>State/Country:</td> <td>SINGAPORE</td> </tr> <tr> <td>Postal Code:</td> <td>738406</td> </tr> </table>		Name:	GLOBALFOUNDRIES Singapore Pte. Ltd.	Street Address:	60 Woodlands Industrial Park D Street 2	City:	Singapore	State/Country:	SINGAPORE	Postal Code:	738406
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CORRESPONDENCE DATA											
<p>Fax Number: 6568462005  <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: +65 9836 9908        Email: oa.notification@horizonip.com.sg        Correspondent Name: Horizon IP Pte Ltd.        Address Line 1: 7500A Beach Road, #04-306/308        Address Line 2: The Plaza        Address Line 4: Singapore, SINGAPORE 199591</p>											
ATTORNEY DOCKET NUMBER:	GFSP2013NAT37US0										
NAME OF SUBMITTER:	Dexter CHIN										
Signature:	/dexter chin/										
Date:	09/20/2013										

CH \$40.00 14032206

This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 2**

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**COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)**

<b>Title of Invention</b>	WAFER PROCESSING
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**DECLARATION**

As the below named inventor, I hereby declare that:

This declaration is directed to: ☒ The attached application, or  
☐ United States application or PCT international application number \_\_\_\_\_ filed on \_\_\_\_\_

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.

**ASSIGNMENT**


For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.

If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.

**LEGAL NAME OF INVENTOR**

Inventor: Liang LI Date: 05 / Sep / 2013

Signature: 

**Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.**

**COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)****Title of  
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**ASSIGNMENT**

For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.

**If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.**

**LEGAL NAME OF INVENTOR**

Inventor: Wei LU

Date:

5 Sep 2013

Signature:



Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.